



Parameters	Ratings	Units
Blocking Voltage	600	V_P
Load Current	130	mA_{rms} / mA_{DC}
On-Resistance (max)	35	Ω

Features

- 5000V_{rms} Input/Output Isolation
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Small 6-Pin Package
- Machine Insertable, Wave Solderable

Applications

- Sensor Circuitry
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment: Patient/Equipment Isolation
- Aerospace
- Industrial Controls

Description

The PLA194 is a single-pole, normally open (1-Form-A) solid state relay that uses optically coupled relay technology to provide an enhanced 5000V_{rms} isolation barrier between the input and the output of the relay.

Its optically coupled outputs, which use the patented OptoMOS architecture, are controlled by a highly efficient GaAIAs infrared LED.

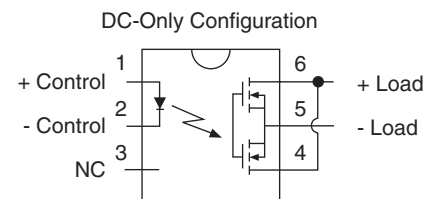
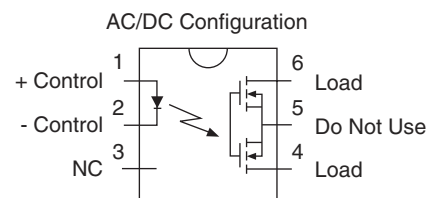
Approvals

- UL-Recognized Component: File Number E76270
- CSA Certified Component: Certificate 1117539
- Certified to EN/IEC 60950-1:
TUV Certificate B 10 05 49410 006

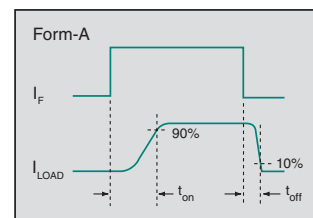
Ordering Information

Part #	Description
PLA194	6-Pin DIP (50/Tube)
PLA194S	6-Pin Surface Mount (50/Tube)
PLA194STR	6-Pin Surface Mount (1000/Reel)

Pin Configuration



Switching Characteristics of Normally Open Devices



Absolute Maximum Ratings @ 25°C

Parameter	Min	Max	Units
Blocking Voltage	-	600	V _P
Reverse Input Voltage	-	5	V
Input Control Current	-	50	mA
Peak (10ms)	-	1	A
Input Power Dissipation ¹	-	150	mW
Total Package Dissipation ²	-	800	mW
ESD Rating, Human Body Model	8	-	kV
Isolation Voltage, Input to Output	5000	-	V _{rms}
Operational Temperature	-40	85	°C
Storage Temperature	-40	125	°C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

¹ Derate linearly 1.33 mW / °C

² Derate linearly 6.67 mW / °C

Electrical Characteristics @ 25°C

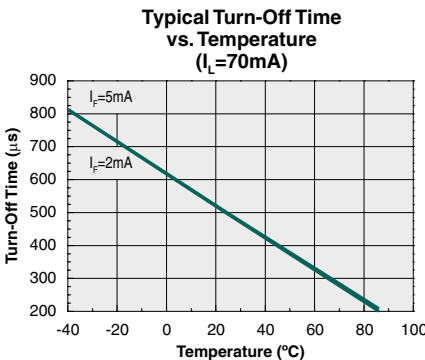
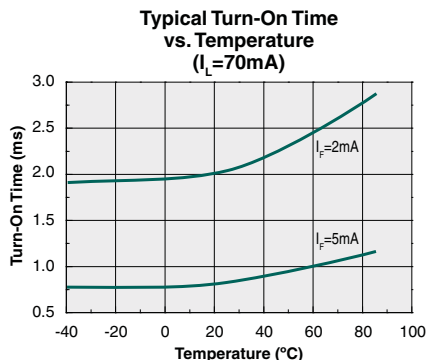
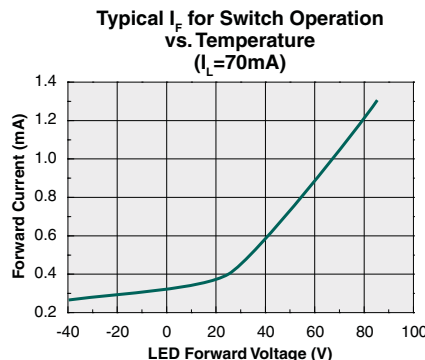
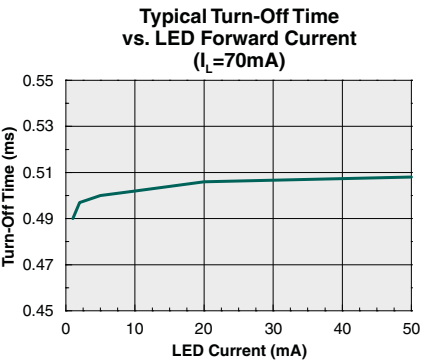
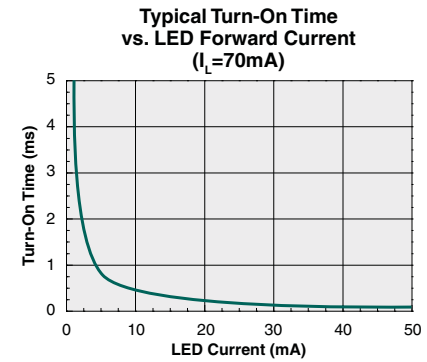
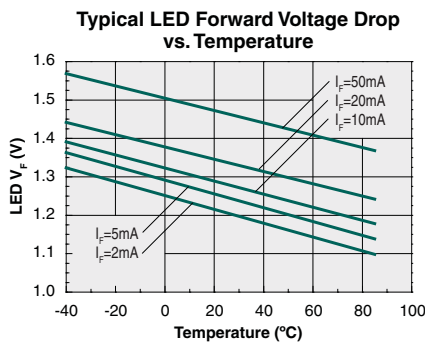
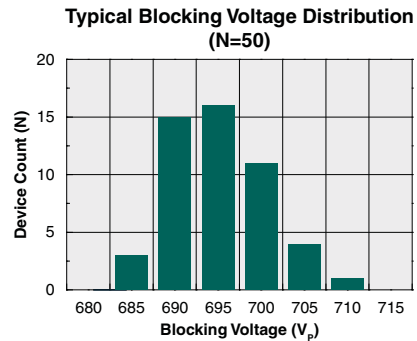
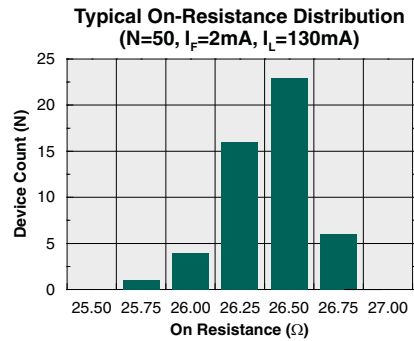
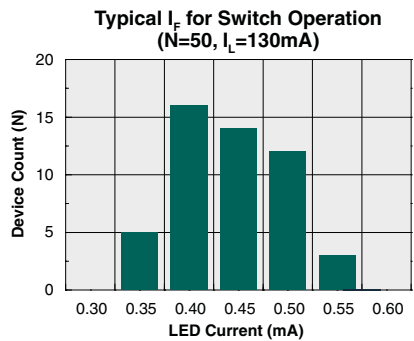
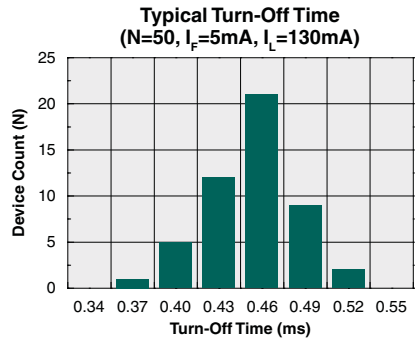
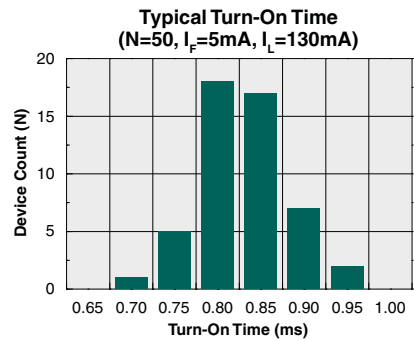
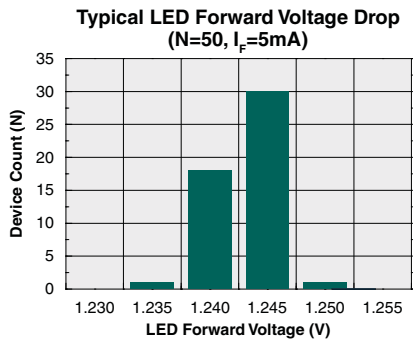
Parameters	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics						
Load Current ¹						
Continuous, AC/DC Configuration	-	I _L	-	-	130	mA _{rms} / mA _{DC}
Continuous, DC-Only Configuration	-		-	-	200	mA _{DC}
Peak	t=10ms	I _{LPK}	-	-	±400	mA _P
On-Resistance ²						
AC/DC Configuration	I _L =130mA	R _{ON}	-	26	35	Ω
DC-Only Configuration	I _L =200mA		-	-	18	
Off-State Leakage Current	V _L =600V _P	I _{LEAK}	-	-	1	μA
Switching Speeds						
Turn-On	I _F =5mA, V _L =10V	t _{on}	-	0.85	3	ms
Turn-Off		t _{off}	-	0.46	2	
Output Capacitance	V _L =50V, f=1MHz	C _{OUT}	-	5	-	pF
Input Characteristics						
Input Control Current to Activate ³	I _L =130mA	I _F	-	0.44	2	mA
Input Control Current to Deactivate	-	I _F	0.1	-	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Common Characteristics						
Input to Output Capacitance	-	C _{I/O}	-	3	-	pF

¹ Load current derates linearly from 130mA @ 25°C to 65mA @ 85°C.

² Measurement taken within 1 second of on-time.

³ For applications requiring high temperature operation (greater than 60°C), a LED drive current of 3mA is recommended.

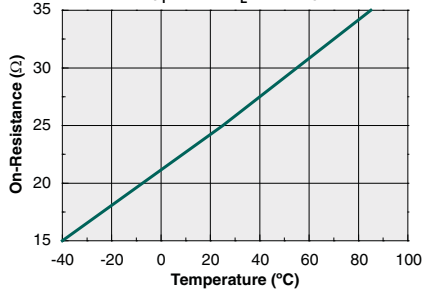
PERFORMANCE DATA @ 25°C (Unless Otherwise Noted) *



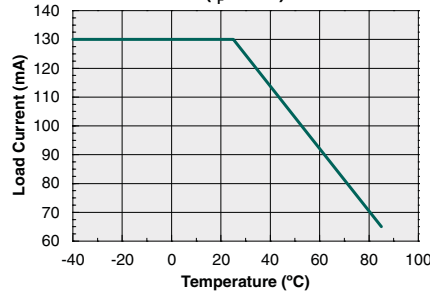
*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA @ 25°C (Unless Otherwise Noted) *

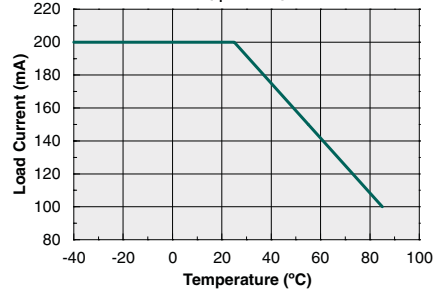
Typical On-Resistance vs. Temperature
($I_F=2mA, I_L=70mA$)



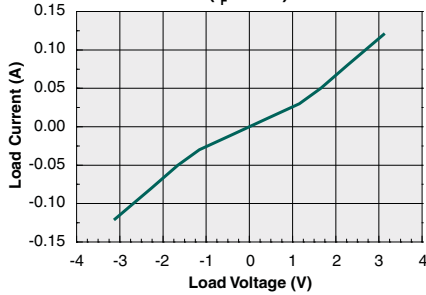
Maximum Load Current vs. Temperature
AC/DC Configuration
($I_F=2mA$)



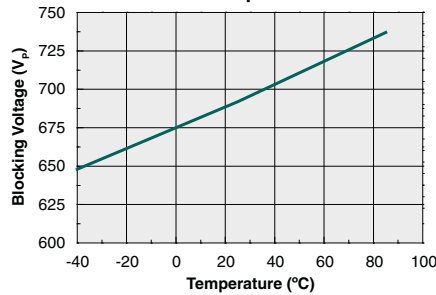
Maximum Load Current vs. Temperature
DC-Only Configuration
($I_F=2mA$)



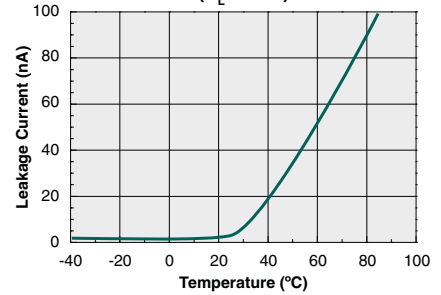
Typical Load Current vs. Load Voltage
($I_F=2mA$)



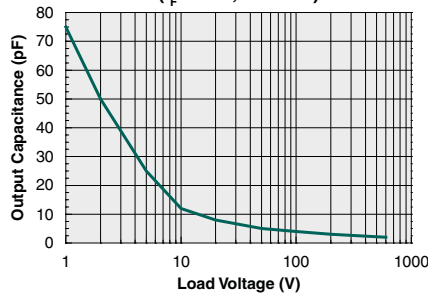
Typical Blocking Voltage vs. Temperature



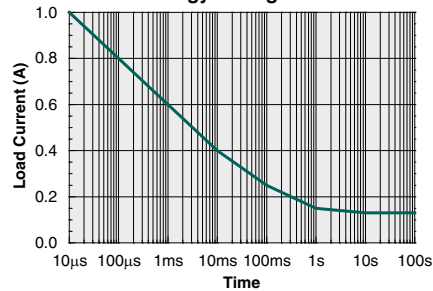
Typical Leakage vs. Temperature
($V_L=600V$)



Output Capacitance vs. Load Voltage
($I_F=0mA, f=1MHz$)



Energy Rating Curve



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

Manufacturing Information

Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
PLA194 / PLA194S	MSL 1

ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
PLA194 / PLA194S	250°C for 30 seconds

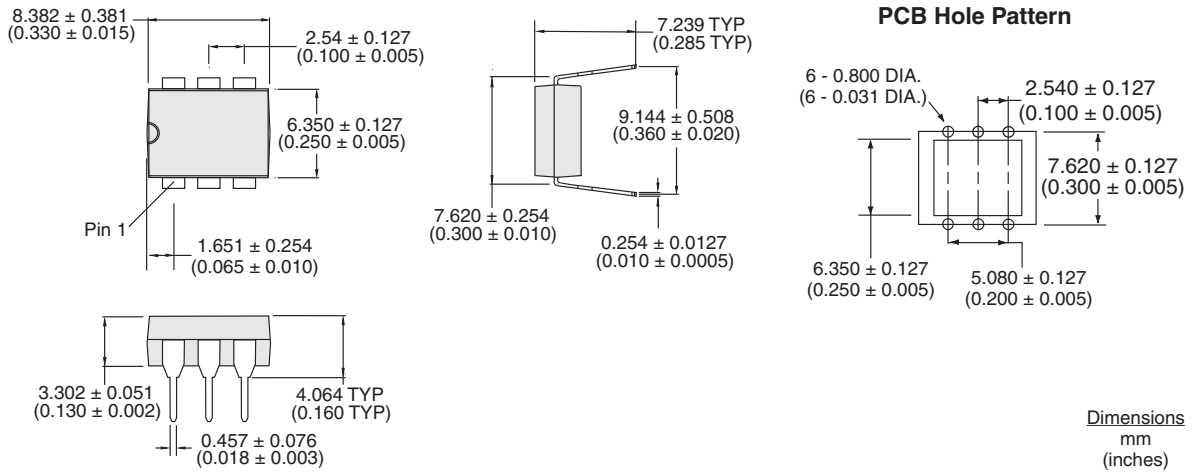
Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

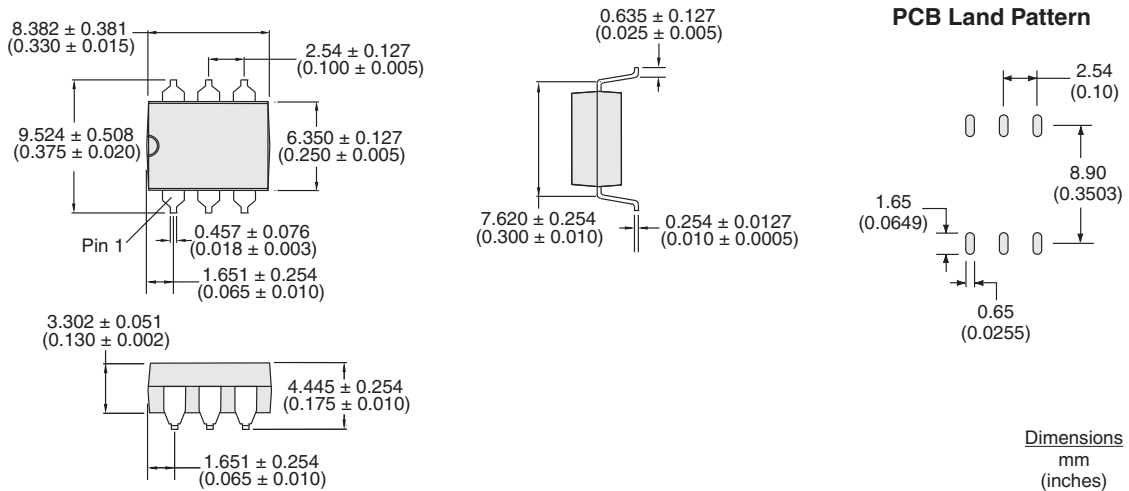


Mechanical Dimensions

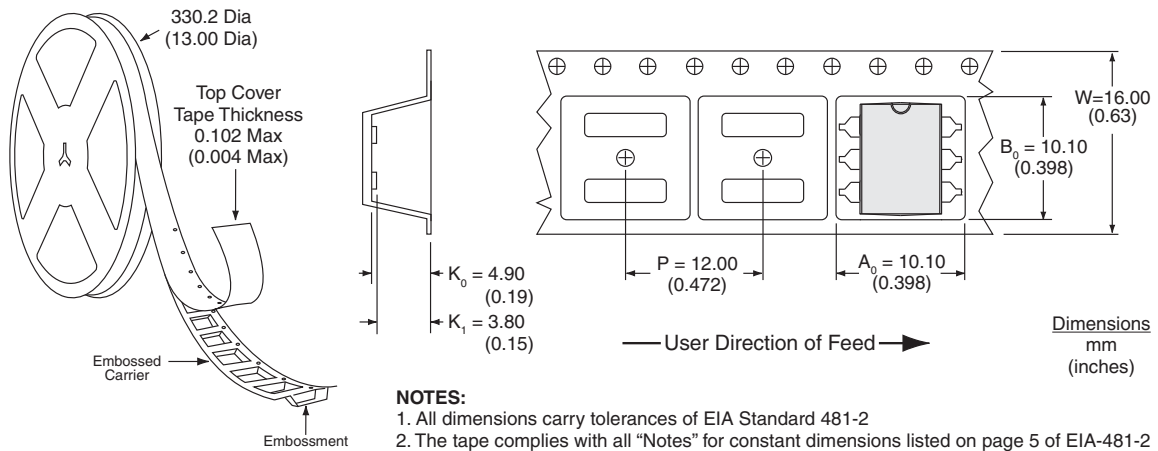
PLA194



PLA194S



PLA194STR Tape & Reel



For additional information please visit our website at: www.ixysic.com

IXYS Integrated Circuits Division makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in IXYS Integrated Circuits Division's Standard Terms and Conditions of Sale, IXYS Integrated Circuits Division assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of IXYS Integrated Circuits Division's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. IXYS Integrated Circuits Division reserves the right to discontinue or make changes to its products at any time without notice.